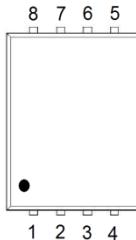


NIKO-SEM
**Dual N-Channel Enhancement Mode
Field Effect Transistor**
P0603YK
PDFN 5x6P
Halogen-Free & Lead-Free
PRODUCT SUMMARY

	$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D^3
Q2	30V	5.8mΩ	61A
Q1	30V	9mΩ	43A


 1 : G1
 2,3,4 : D1
 5,6,7 : S2
 8 : G2
 9 : S1/D2
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	Q2	Q1	UNITS
Drain-Source Voltage		V_{DS}	30	30	V
Gate-Source Voltage		V_{GS}	± 20	± 20	V
Continuous Drain Current ³	$T_C = 25^\circ\text{C}$	I_D	61	43	A
	$T_C = 100^\circ\text{C}$		38	21	
Pulsed Drain Current ¹		I_{DM}	130	120	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	15	11	W
	$T_A = 70^\circ\text{C}$		12	9	
Avalanche Current		I_{AS}	36	25	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	64	31	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	35	27	W
	$T_C = 100^\circ\text{C}$		14	10	
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	2.3	1.9	W
	$T_A = 70^\circ\text{C}$		1.5	1.2	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL		TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$	Q2		53	°C / W
	$R_{\theta JA}$	Q1		65	
Junction-to-Case	$R_{\theta JC}$	Q2		3.5	
	$R_{\theta JC}$	Q1		4.6	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

³Package limitation current : Q1=27A, Q2=31A

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
STATIC							
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	Q2	30			
			Q1	30			
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	Q2	1	1.6	3	
			Q1	1	1.7	3	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$	Q2			± 100	
			Q1			± 100	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$	Q2			1	
			Q1			1	
		$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$	Q2			10	
			Q1			10	
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 12\text{A}$	Q2		5.7	7	
		$V_{\text{GS}} = 4.5\text{V}, I_D = 9\text{A}$	Q1		9.7	14	
		$V_{\text{GS}} = 10\text{V}, I_D = 15\text{A}$	Q2		4.4	5.8	
		$V_{\text{GS}} = 10\text{V}, I_D = 11\text{A}$	Q1		7.5	9	
Forward Transconductance ¹	g_{fs}	$V_{\text{GS}} = 5\text{V}, I_D = 15\text{A}$	Q2		57		
		$V_{\text{GS}} = 5\text{V}, I_D = 11\text{A}$	Q1		55		
DYNAMIC							
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 15\text{V}, f = 1\text{MHz}$	Q2		1740	pF	
Output Capacitance	C_{oss}		Q1		877		
Reverse Transfer Capacitance	C_{rss}		Q2		223		
			Q1		128		
Gate Resistance	R_g		Q2		199		
			Q1		115		
Total Gate Charge ²	Q_g	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$	Q2		1	Ω	
			Q1		2.1		
Gate-Source Charge ²	Q_{gs}		Q2		40.3	nC	
			Q1		23		
Gate-Drain Charge ²	Q_{gd}		Q2		21.1		
			Q1		12.4		
			Q2		6		
			Q1		3.2		
			Q2		9.8		
			Q1		6.5		

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Turn-On Delay Time ²	$t_{d(on)}$	Q2 $V_{DS} = 15V$, $I_D = 15A$, $V_{GS} = 10V$, $R_{GEN} = 6\Omega$ Q1 $V_{DS} = 15V$, $I_D = 11A$, $V_{GS} = 10V$, $R_{GEN} = 6\Omega$	Q2	23		
Rise Time ²	t_r		Q1	20		
Turn-Off Delay Time ²	$t_{d(off)}$		Q2	18		
Fall Time ²	t_f		Q1	12		
			Q2	56		
			Q1	41		
			Q2	28		
			Q1	22		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current ³	I_S		Q2		61	A
			Q1		43	
Forward Voltage ¹	V_{SD}	$I_F = 15A$, $V_{GS} = 0V$	Q2	0.83	1.3	V
		$I_F = 11A$, $V_{GS} = 0V$	Q1	0.87	1.3	
Reverse Recovery Time	t_{rr}	Q2 $I_F = 15A$, $dI_F/dt = 100A/\mu S$	Q2	15		nS
		Q1	Q1	11.7		
Reverse Recovery Charge	Q_{rr}	Q1 $I_F = 11A$, $dI_F/dt = 100A/\mu S$	Q2	5.1		nC
			Q1	3		

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Package limitation current : Q1=27A, Q2=31A

NIKO-SEM

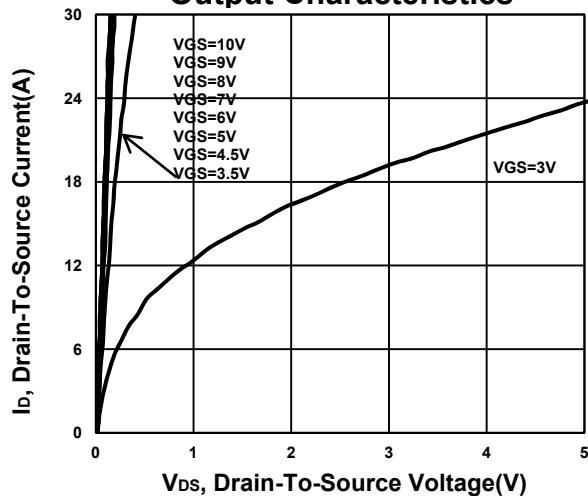
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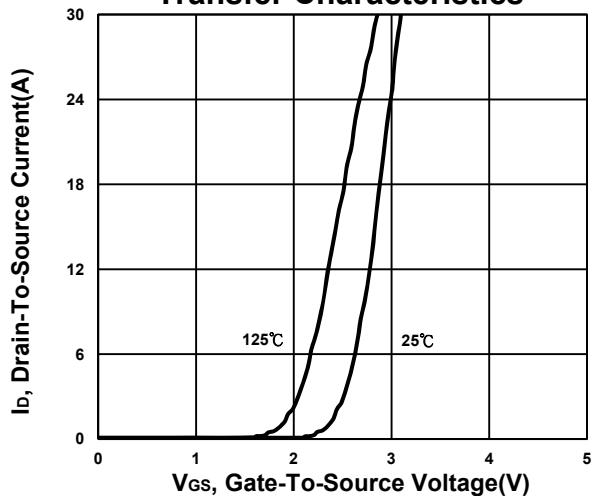
TYPICAL PERFORMANCE CHARACTERISTICS

Q2

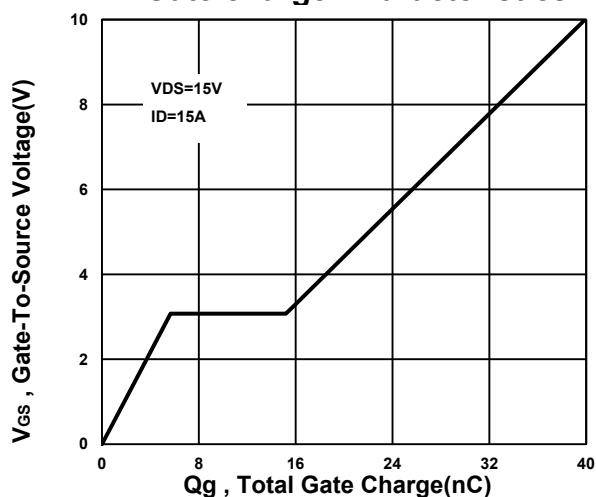
Output Characteristics



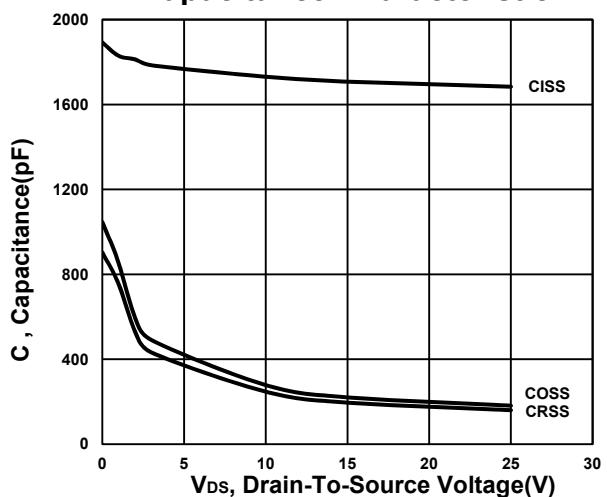
Transfer Characteristics



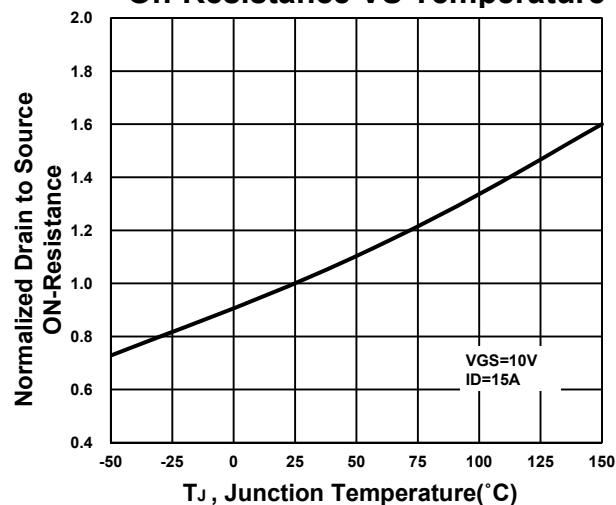
Gate charge Characteristics



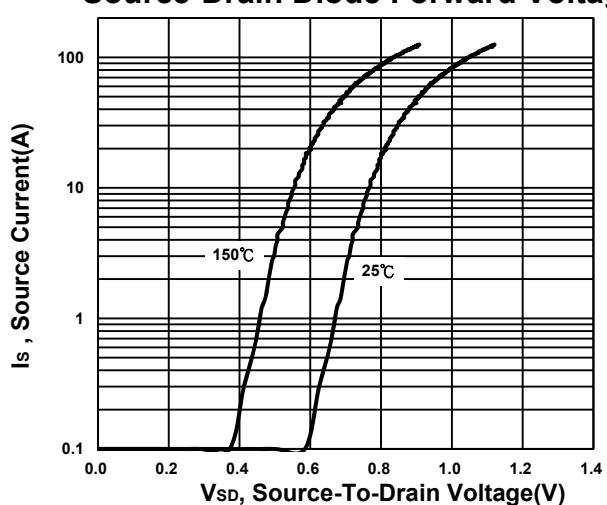
Capacitance Characteristic



On-Resistance VS Temperature



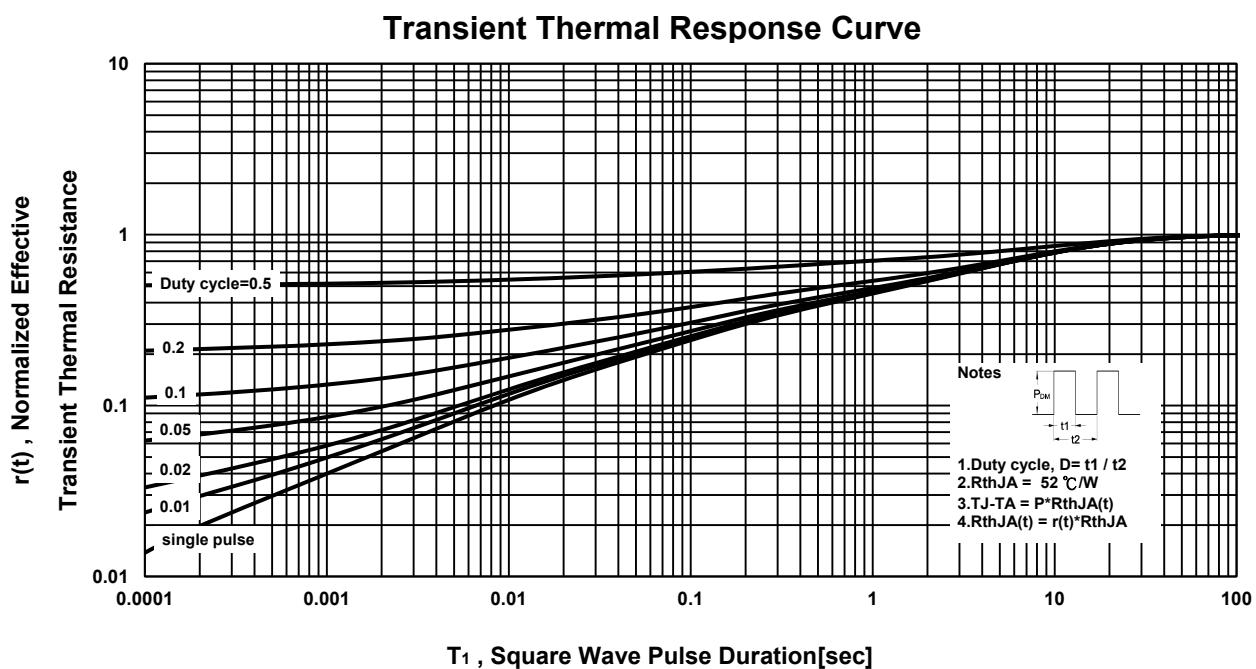
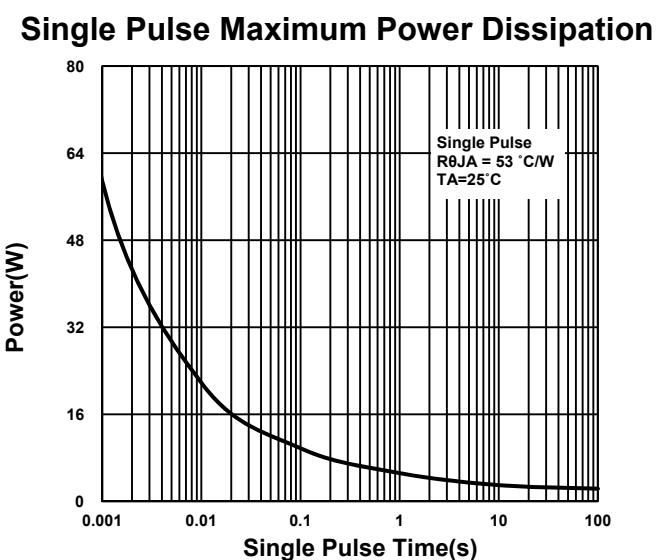
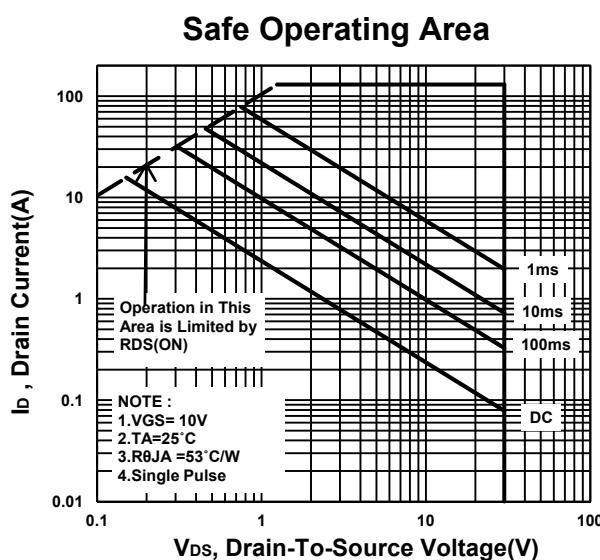
Source-Drain Diode Forward Voltage



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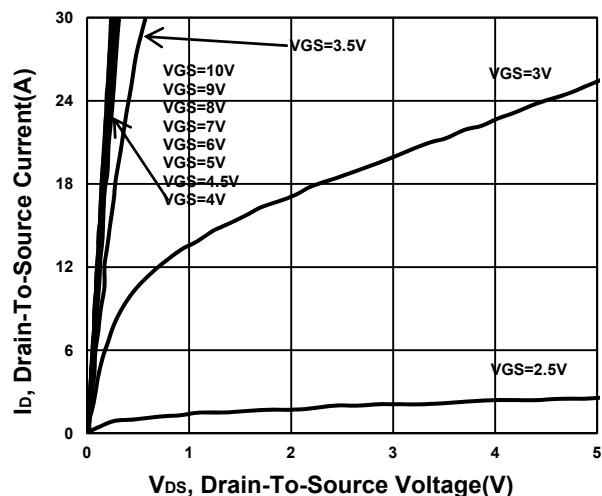
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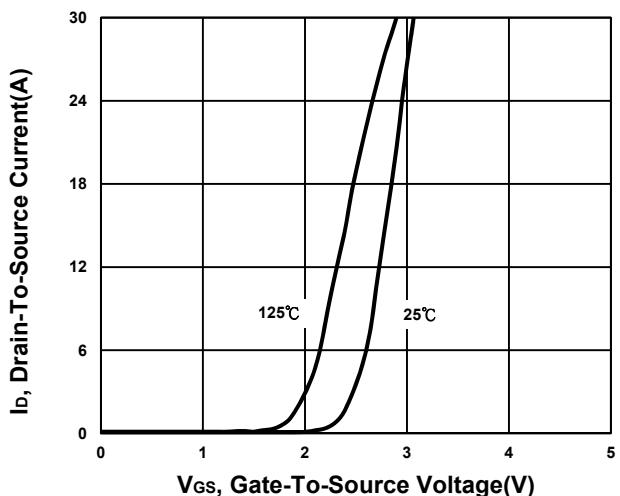
P0603YK
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TYPICAL PERFORMANCE CHARACTERISTICS Q1

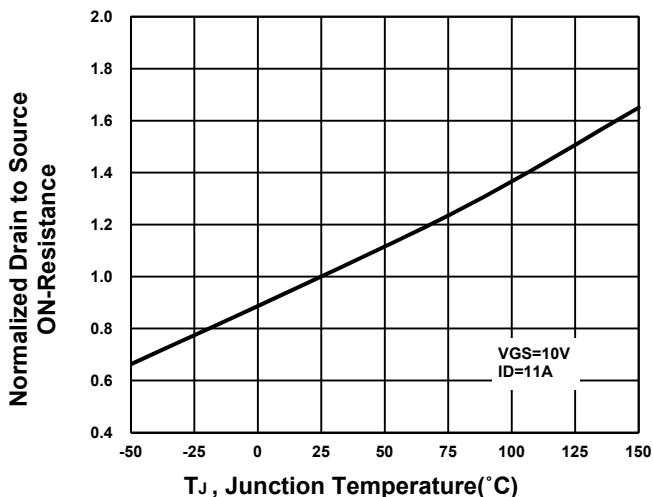
Output Characteristics



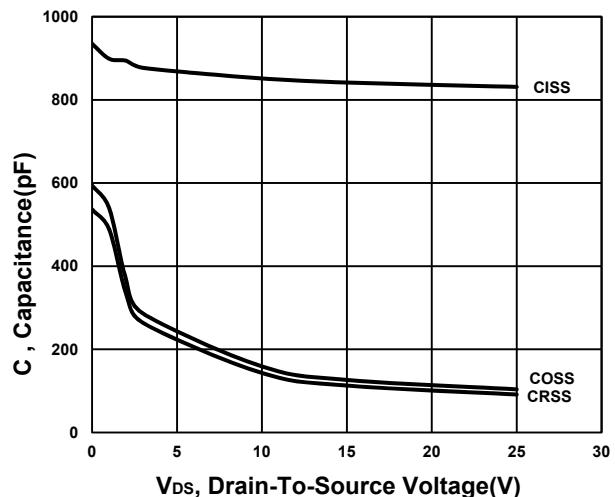
Transfer Characteristics



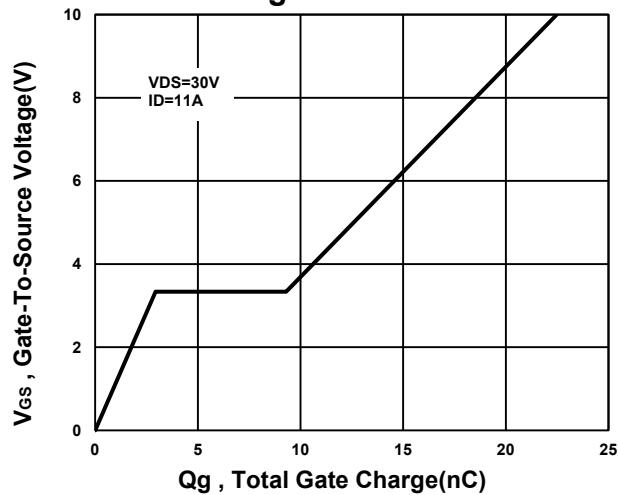
On-Resistance VS Temperature



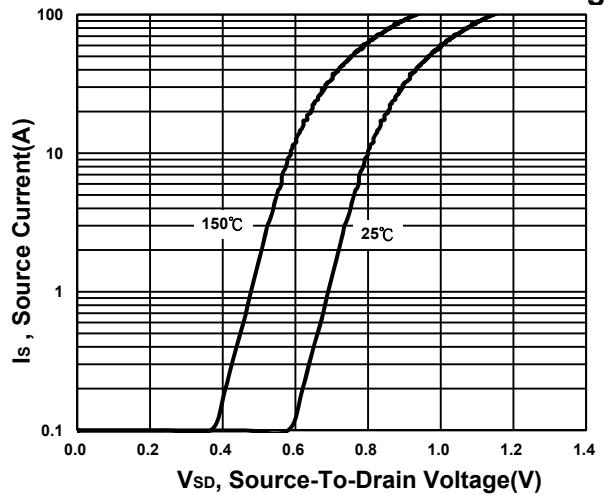
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage



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